

# LOCTITE ABLESTIK ABP 3600T

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## PRODUCT DESCRIPTION

LOCTITE ABLESTIK ABP 3600T provides the following product characteristics:

<b>Technology</b>	Proprietary Hybrid Chemistry
<b>Appearance</b>	Silver
<b>Cure</b>	Heat cure
<b>Product Benefits</b>	<ul style="list-style-type: none"> <li>• Excellent adhesion to Ag plated LF</li> <li>• Oven Curable</li> <li>• Snap curable</li> <li>• Low bleed</li> </ul>
<b>Application</b>	Die attach
<b>Key Substrates</b>	PPF and Silver
<b>Filler Type</b>	Silver

LOCTITE ABLESTIK ABP 3600T electrically conductive die attach adhesive is designed for high reliability package applications requiring moderate thermal and electrical requirements. This material offers improved JEDEC performance in L/F packages, especially on spot Ag and PPF L/Fs.

## TYPICAL PROPERTIES OF UNCURED MATERIAL

Viscosity, Brookfield CP51, 25 °C, mPa·s (cP):	
Speed 5 rpm	8,880
Thixotropic Index (0.5/5 rpm)	5.0
Work Life @ 25°C, hours	24
Shelf Life @ -40°C (from date of manufacture), days	365

## TYPICAL CURING PERFORMANCE

### Cure Schedule

30 minute ramp to 175°C + 15 minutes @ 175°C

### Recommended Snap Cure Condition

Zone No.	1	2	3	4	5	6	7	Total Time
Temp °C	140	140	170	220	220	220	220	3 min

**Note:** N2 Flow: 20 liters/ minute @ 150°C

### Weight Loss on Cure

10 x 10 mm Si die on glass slide, % 7.0

The above cure profiles are guideline recommendations. Cure conditions (time and temperature) may vary based on customers' experience and their application requirements, as well as customer curing equipment, oven loading and actual oven temperatures.

## TYPICAL PROPERTIES OF CURED MATERIAL

### Physical Properties

Coefficient of Thermal Expansion, ppm/°C:	
Below Tg	60
Above Tg	195
Glass Transition Temperature, DMTA, °C	240
Thermal Conductivity, W/(m-K)	2.5
Tensile Modulus, DMTA :	
@ 25 °C	N/mm <sup>2</sup> 7,840 (psi) (1,137,096)
@ 150 °C	N/mm <sup>2</sup> 5,090 (psi) (738,242)
@ 250 °C	N/mm <sup>2</sup> 2,900 (psi) (420,609)
Extractable Ionic Content, @ 100°C ppm:	
Chloride (Cl-)	<10
Sodium (Na+)	<10
Potassium (K+)	<30

### Electrical Properties

Volume Resistivity, ohms-cm 8.1×10<sup>-5</sup>

## TYPICAL PERFORMANCE OF CURED MATERIAL

### Shear Strength

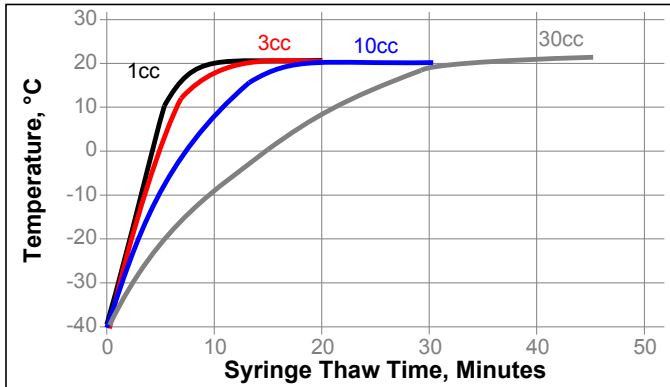
120 x 120 mils Si die on Ag/Cu LF @ 25 °C, kg-f 17

## GENERAL INFORMATION

For safe handling information on this product, consult the Safety Data Sheet, (SDS).

### THAWING:

1. Allow container to reach room temperature before use.
2. After removing from the freezer, set the syringes to stand vertically while thawing.
3. Refer to the Syringe Thaw time chart for the thaw time recommendation.
4. DO NOT open the container before contents reach 25°C temperature. Any moisture that collects on the thawed container should be removed prior to opening the container.
5. DO NOT re-freeze. Once thawed to -40°C, the adhesive should not be re-frozen.



#### DIRECTIONS FOR USE

1. Thawed material should immediately be placed on dispense equipment for use.
2. If the adhesive is transferred to a final dispensing reservoir, care must be exercised to avoid entrapment of contaminants and/or air into the adhesive.
3. Adhesive must be completely used within the product's recommended work life.
4. Silver-resin separation may occur if the adhesive is left out at room temperature, beyond the recommended work life.
5. Apply enough adhesive to achieve a 25 to 50  $\mu\text{m}$  wet bondline thickness, dispensed with approximately 25 to 50 % filleting on all sides of the die.
6. Alternate dispense amounts may be used depending on the application requirements.
7. Star or crossed shaped dispense patterns will yield fewer bondline voids than the matrix style of dispense pattern.

#### Not for product specifications

The technical data contained herein are intended as reference only. Please contact your local quality department for assistance and recommendations on specifications for this product.

#### STORAGE:

Store product in the unopened container in a dry location. Storage information may be indicated on the product container labeling.

**Optimal Storage: -40 °C. Storage below minus (-)40 °C or greater than minus (-)40 °C can adversely affect product properties.**

Material removed from containers may be contaminated during use. Do not return product to the original container. Henkel Corporation cannot assume responsibility for product which has been contaminated or stored under conditions other than those previously indicated. If additional information is required, please contact your local Technical Service Center or Customer Service Representative.

#### Conversions

$(^{\circ}\text{C} \times 1.8) + 32 = ^{\circ}\text{F}$   
 $\text{kV/mm} \times 25.4 = \text{V/mil}$   
 $\text{mm} / 25.4 = \text{inches}$   
 $\text{N} \times 0.225 = \text{lb}$   
 $\text{N/mm} \times 5.71 = \text{lb/in}$   
 $\text{psi} \times 145 = \text{N/mm}^2$   
 $\text{MPa} = \text{N/mm}^2$   
 $\text{N}\cdot\text{m} \times 8.851 = \text{lb}\cdot\text{in}$   
 $\text{N}\cdot\text{m} \times 0.738 = \text{lb}\cdot\text{ft}$   
 $\text{N}\cdot\text{mm} \times 0.142 = \text{oz}\cdot\text{in}$   
 $\text{mPa}\cdot\text{s} = \text{cP}$

#### Disclaimer

##### Note:

The information provided in this Technical Data Sheet (TDS) including the recommendations for use and application of the product are based on our knowledge and experience of the product as at the date of this TDS. The product

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